





#### 100V N-CHANNEL ENHANCEMENT MODE MOSFET

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub> T <sub>A</sub> = 25°C		
100\/	350mΩ @ Vgs = 10V	3.5A		
100V	450mΩ @ VGS = 6V	3.1A		

## **Description and Applications**

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor control
- DC-DC Converters
- Power management functions
- Uninterrupted power supply

#### **Features and Benefits**

- Fast switching speed
- Low input capacitance
- "Green" Component and RoHS compliant (Note 1)
- Qualified to AEC-Q101 Standards for High Reliability

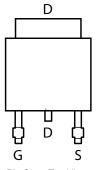
#### **Mechanical Data**

- Case: TO252-3L
- Case Material: Molded Plastic "Green" Molding Compound, UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Matte Tin Finish annealed over Copper leadframe.
   Solderable per MIL-STD-202, Method 208
- · Weight: 0.33 grams (approximate)

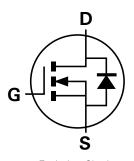




Top View



Pin Out - Top View



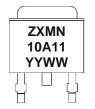
Equivalent Circuit

#### Ordering Information (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXMN10A11KTC	See Below	13	16	2,500

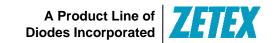
Note: 1. Diodes, Inc. defines "Green" products as those which are RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website.

## **Marking Information**



ZXMN = Product Type Marking Code, Line 1 10A11 = Product Type Marking Code, Line 2 YYWW = Date Code Marking YY = Year (ex: 09 = 2009) WW = Week (01-52)





#### **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

С	haracteristic		Symbol	Value	Unit
Drain-Source voltage			V <sub>DSS</sub>	100	V
Gate-Source voltage			V <sub>GS</sub>	±20	V
Continuous Drain current V <sub>GS</sub> = 10V		(Note 3) T <sub>A</sub> = 70°C (Note 3) (Note 2)	I <sub>D</sub>	3.5 2.8 2.4	А
Pulsed Drain current V <sub>GS</sub> = 10V		(Note 4)	I <sub>DM</sub>	9.9	Α
Continuous Source current (Body diode) (Note 3)		I <sub>S</sub>	8.4	A	
Pulsed Source current (Body diode) (Note 4)		I <sub>SM</sub>	9.9	A	

### Thermal Characteristics @TA = 25°C unless otherwise specified

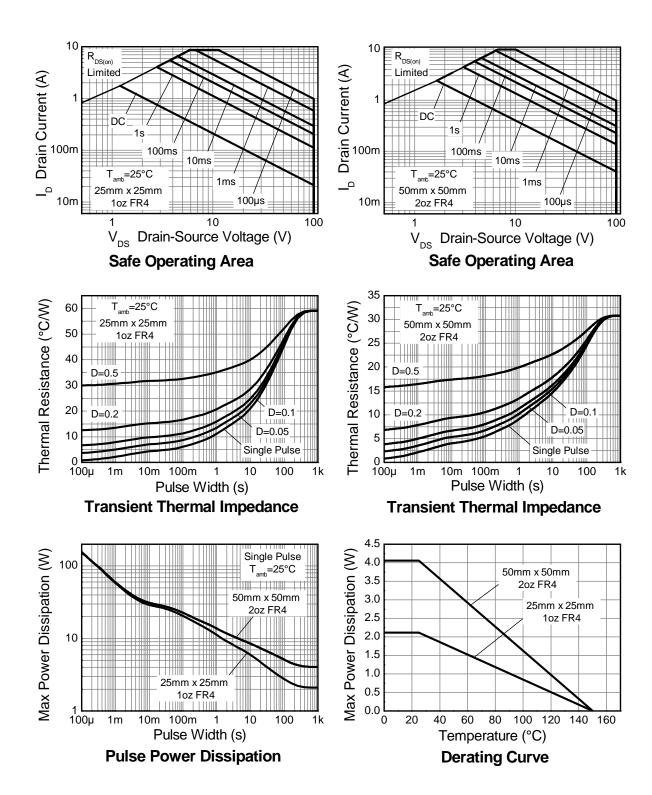
Characteristic	Symbol	Value	Unit	
	(Note 2)		4.06 32.4	
Power dissipation Linear derating factor	(Note 3)	P <sub>D</sub>	8.5 68.0	W mW/°C
	(Note 6)		2.11 16.8	
	(Note 2)		30.8	
Thermal Resistance, Junction to Ambient	(Note 3)	$R_{ heta JA}$	14.7	°C/W
	(Note 6)	·	59.1	
Thermal Resistance, Junction to Lead	(Note 5)	$R_{ hetaJL}$	1.10	°C/W
Operating and storage temperature range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C

#### Notes:

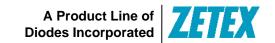
- 2. For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 3. Same as note 2, except the device is measured at  $t \le 10$  sec.
- 4. Same as note 2, except the device is pulsed with D = 0.02 and pulse width 300 µs. The pulse current is limited by the maximum junction temperature.
- 5. Thermal resistance from junction to solder-point (at the end of the drain lead).
- 6. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with the high coverage single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.



### **Thermal Characteristics**







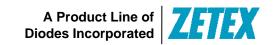
## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Min	Тур	Max	Unit	Test Co	ndition		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage	$BV_{DSS}$	100		_	V	$I_D = 250 \mu A, V_{GS} = 100 \mu A$	= 0V		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 100V, V_{GS}$	= 0V		
Gate-Source Leakage	IGSS		_	±100	nA	$V_{GS} = \pm 20V, V_{DS}$	= 0V		
ON CHARACTERISTICS	0 100								
Gate Threshold Voltage	V <sub>GS(th)</sub>	2		4	V	$I_D = 250 \mu A, V_{DS}$	= V <sub>G</sub> S		
Static Drain Source On Begintance (Note 7)				0.350	Ω	$V_{GS} = 10V, I_D = 2$	2.6A		
Static Drain-Source On-Resistance (Note 7)	R <sub>DS</sub> (ON)			0.450	12	$V_{GS} = 6V, I_D = 1.$	3A		
Forward Transconductance (Notes 7 & 8)	g <sub>fs</sub>	_	4	_	S	$V_{DS} = 15V, I_{D} = 2$	2.6A		
Diode Forward Voltage (Note 7)	$V_{SD}$	_	0.850	0.950	V	I <sub>S</sub> = 1.85A, V <sub>GS</sub> =	: 0V		
Reverse recovery time (Note 8)	t <sub>rr</sub>	_	26	_	ns	1 4 0 4 -1:/-14	4004/ -		
Reverse recovery charge (Note 8)		_	30	_	nC	$I_S = 1.0A$ , di/dt =	100Α/μ\$		
DYNAMIC CHARACTERISTICS (Note 8)	411								
Input Capacitance	C <sub>iss</sub>		274	_	pF	501/1/	0) (		
Output Capacitance	Coss		21	_	pF	V <sub>DS</sub> = 50V, V <sub>GS</sub> = 0V f = 1MHz			
Reverse Transfer Capacitance	Crss		11	_	pF	1 = 11/11/12			
Total Gate Charge (Note 9)	$Q_g$	_	3.5	_	nC	$V_{GS} = 6V$			
Total Gate Charge (Note 9)	Qq	_	5.4	_	nC		$V_{DS} = 50V$ ,		
Gate-Source Charge (Note 9)	Q <sub>gs</sub>	_	1.4	_	nC	$V_{GS} = 10V$ $I_{D} = 2.5A$			
Gate-Drain Charge (Note 9)	$Q_{gd}$	_	1.5	_	nC				
Turn-On Delay Time (Note 9)	t <sub>D(on)</sub>	_	2.7	_	ns				
Turn-On Rise Time (Note 9)	t <sub>r</sub>	_	1.7	_	ns	$V_{DD} = 50V, V_{GS} = 10V$			
Turn-Off Delay Time (Note 9)	t <sub>D(off)</sub>		7.4	_	ns	$I_D = 1.0A, R_G \cong 6\Omega$			
Turn-Off Fall Time (Note 9)	t <sub>f</sub>	_	3.5	_	ns				

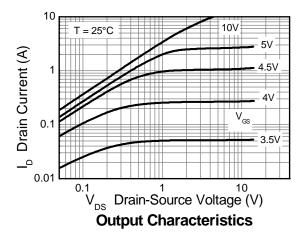
Notes:

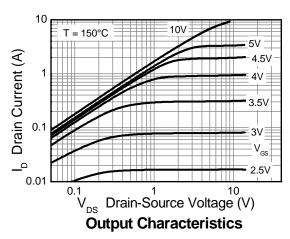
- 7. Measured under pulsed conditions. Pulse width  $\leq 300 \mu s$ ; duty cycle  $\leq 2\%$
- 8. For design aid only, not subject to production testing.
  9. Switching characteristics are independent of operating junction temperatures.

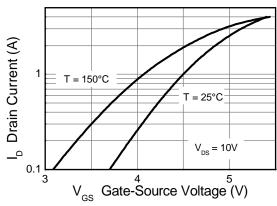


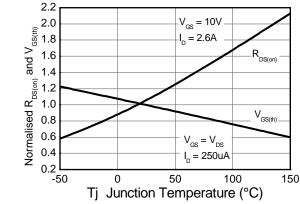


## **Typical Characteristics**



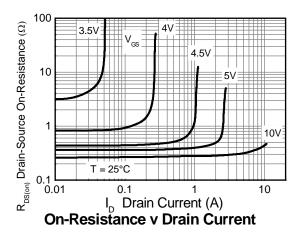


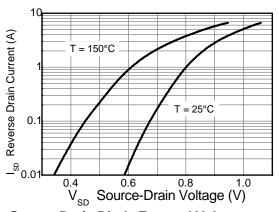




**Typical Transfer Characteristics** 



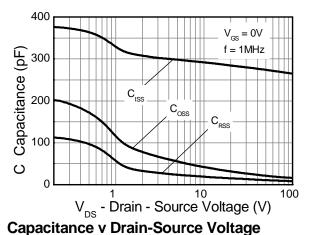


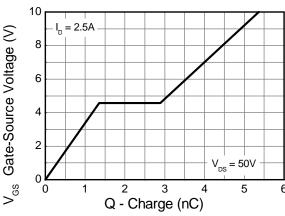


Source-Drain Diode Forward Voltage



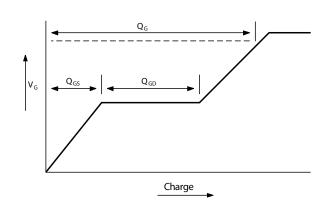
## **Typical Characteristics - continued**



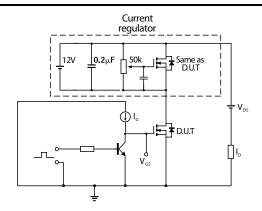


Gate-Source Voltage v Gate Charge

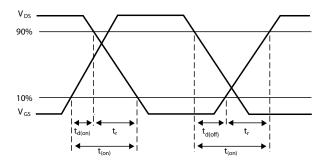
### **Test Circuits**



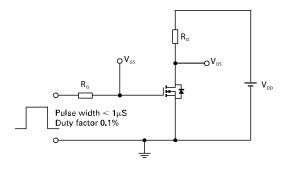
Basic gate charge waveform



Gate charge test circuit

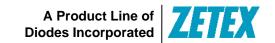


Switching time waveforms

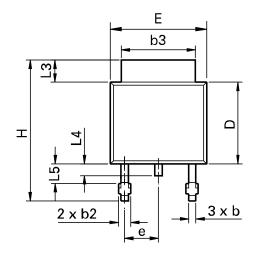


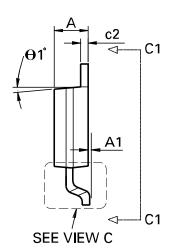
Switching time test circuit

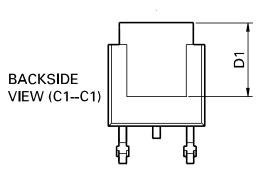


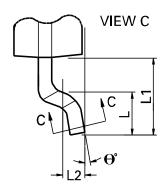


# **Package Outline Dimensions**



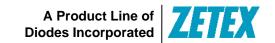




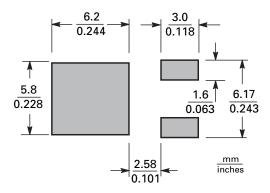


DIM	DIM Inches		Millimeters		DIM	Inches		Millimeters	
	Min	Max	Min	Max		Min	Max	Min	Max
Α	0.086	0.094	2.18	2.39	е	0.090 BSC		2.29 BSC	
A1	-	0.005	-	0.127	Н	0.370	0.410	9.40	10.41
b	0.020	0.035	0.508	0.89	L	0.055	0.070	1.40	1.78
b2	0.030	0.045	0.762	1.14	L1	0.108 REF		2.74 REF	
b3	0.205	0.215	5.21	5.46	L2	0.020 BSC		0.508 BSC	
С	0.018	0.024	0.457	0.61	L3	0.035	0.065	0.89	1.65
c2	0.018	0.023	0.457	0.584	L4	0.025	0.040	0.635	1.016
D	0.213	0.245	5.41	6.22	L5	0.045	0.060	1.14	1.52
D1	0.205	-	5.21	-	θ1°	0°	10°	0°	10°
E	0.250	0.265	6.35	6.73	θ°	0°	15°	0°	15°
E1	0.170	-	4.32	-	-	-	-	-	_





## **Suggested Pad Layout**



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